

**APPLICATION DATA SHEET****Inventor Information**

Inventor One Given Name : Gundu M.  
Family Name : Sabde  
Postal Address Line One : 1524 River Stone Ln. #2  
City : Boise  
State or Province : Idaho  
County : Ada  
Postal or Zip Code : 83706  
City of Residence : Boise  
State or Prov. Of Residence : Idaho  
Country of Residence : USA  
Citizenship Country : India

Inventor Two Given Name : Whonchee  
Family Name : Lee  
Postal Address Line One : 493 S. Browning Avenue  
City : Boise  
State or Province : Idaho  
County : Ada  
Postal or Zip Code : 83709  
City of Residence : Boise  
State or Prov. Of Residence : Idaho  
Country of Residence : USA  
Citizenship Country : USA

**Correspondence Information**

Name Line One : Steven H. Arterberry, Esq.  
Address Line One : DORSEY & WHITNEY LLP  
Address Line Two : 1420 Fifth Avenue, Suite 3400  
City : Seattle  
State or Province : Washington  
Postal or Zip Code : 98101  
Telephone : 206-903-8800  
Facsimile : 206-903-8820  
E-Mail : arterberry.steve@dorseyllaw.com

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**Application Information**

Title : METHODS AND APPARATUSES FOR PLANARIZING  
MICROELECTRONIC SUBSTRATE ASSEMBLIES  
Total Drawing Sheets : 4 (FOUR)  
Formal Drawings : YES  
Application Type : Utility  
Attorney Docket Number : 500163.05  
Assigned : Yes (Large Entity)

**Representative Information**

Representative Customer No. : 27,076

**Continuity Information**

This application is a : divisional of  
>Application One : 09/356,808  
Filing Date : July 20, 1999

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